



Product Change Notification

111652 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 111652 - 01
Change Title: Intel® Server System R2208GZ4GC, R2308GZ4GC, R2312GL4GS and **R2312GZ4GC4**
PCN 111652-01, Product Design, Product Material
Update 2U Rear Panel
Reason for Revision: Adding additional product to change.

Date of Publication: August 21, 2012

Key Characteristics of the Change:
Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Aug 31, 2012
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Description of Change to the Customer:

Reason for Revision: Adding additional product to change.

Intel will implement the following change to Intel® Server System R2208GZ4GC, R2308GZ4GC, R2312GL4GS and **R2312GZ4GC4**:

Add a small cut-out to the system rear panel to provide better clearance for latches on network cables plugging into the Dual Port Intel® X540 10GbE I/O Module AXX10GBTWLIOM.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers; no action is recommended or required.

Products Affected / Intel Ordering Codes:

CORE SKUs			
Product Code	MM#	Pre Change TA	Post Change TA
R2208GZ4GC	917001	G46831-004	G46831-005
R2308GZ4GC	917004	G46826-004	G46826-005
R2312GL4GS	917012	G46829-002	G46829-003
R2312GZ4GC4	921972	G63761-004	G63761-005

PCN Revision History:

Date of Revision:

August 13, 2012

August 21, 2012

Revision Number:

00

01

Reason:

Originally Published PCN

Adding additional product to change.